

## CMPA1D1J001S 12.7 – 18 GHz, 1 W GaN HPA

#### Description

The CMPA1D1J001S is a 1W package MMIC HPA utilizing the high performance, 0.15um GaN on SiC production process. The CMPA1D1J001S operates from 12.7-18 GHz and supports both radar and communication applications within both military and commercial markets. The CMPA1D1J001S achieves 1 W of saturated output power with 23 dB of large signal gain and typically 30% poweradded efficiency under CW operation.

Packaged in a 4x3 mm plastic overmold QFN, the CMPA1D1J001S provides superior broadband performance and environmental robustness in a small form factor allowing customers to improve SWaP-C benchmarks in their next-generation systems.

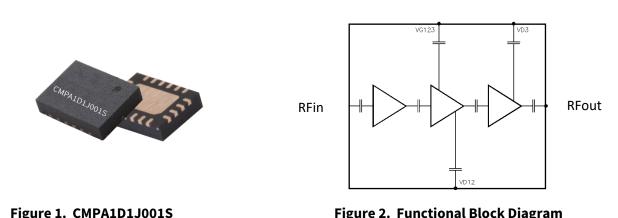


Figure 1. CMPA1D1J001S



#### Features

- Psat: 1W
- PAE: 30 % •
- LSG: 23 dB .
- S21: 27 dB
- S11: -10 dB •
- S22: -8 dB •
- CW operation •
- Small 4 x 3 mm footprint •

#### **Applications**

- Military and Commercial Radar and Communications
- General Purpose Broadband Amplifier

RoHS compliant

Note: Features are typical performance across frequency under 25C operation. Please reference performance charts for additional information.

#### **Absolute Maximum Ratings**

Parameter	Symbol	Units	Value	Conditions
Drain to Source Voltage	V <sub>DSS</sub>	V	84	
Drain Voltage	V <sub>D</sub>	V	28	
Gate Voltage	V <sub>G</sub>	V	-8, +2	
Drain Current	I <sub>D</sub>	А	0.8	
Gate Current	I <sub>G</sub>	mA	1.0	
Input Power	P <sub>in</sub>	dBm	10	
Dissipated Power	P <sub>diss</sub>	W	4.4	85°C
Storage Temperature	T <sub>stg</sub>	°C	-55, +150	
Mounting Temperature	۲٦	°C	260	30 seconds
Junction Temperature	۲٦	°C	225	
Output Mismatch Stress	VSWR	Ψ	5:1	

#### **Recommended Operating Conditions**

Parameter	Symbol	Units	Typical Value	Conditions
Drain Voltage	Vd	V	22	
Gate Voltage	Vg	V	-2.0	
Drain Current	Idq	mA	30	
Input Power	Pin	dBm	8	
Case Temperature	Tcase	°C	-40 to 85	

#### **RF Specifications**

Test conditions unless otherwise noted: Vd=22 V, Idq=30mA, CW, Pin = 8 dBm,  $T_{base}$ =25 °C

Parameter	Units	Frequency	Min	Typical	Мах	Conditions
Frequency	GHz		13		18	
		12.7		30.5		
Output Power	dBm	15.5		31.5		
		18		30.5		
Power-added		12.7		28		
	%	15.5		35		
Efficiency		18		34		
		12.7		22.5		
LSG	dB	15.5		23.5		
		18		22.5		
		12.7		27		
Small-Signal Gain	dB	15.5		30		Pin = -20 dBm
		18		24		
Input Return Loss	dB			-10		Pin = -20 dBm
Output Return Loss	dB			-8		Pin = -20 dBm

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40

35

30

25

20

15

PAE (%)

#### Figure 3: Pout v. Frequency v. Temperature



85 °C

25 °C

-40 °C

12.5 13 13.5 14 14.5 15 15.5 16 16.5 17 17.5 18

Frequency (GHz)

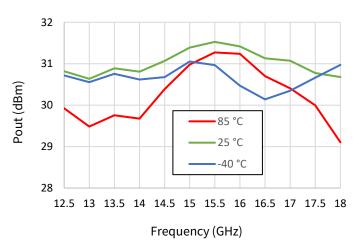


Figure 5: Id v. Frequency v. Temperature

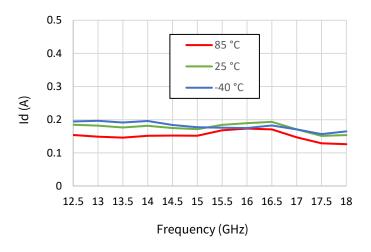
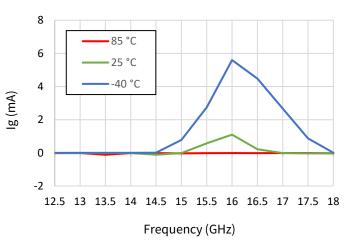
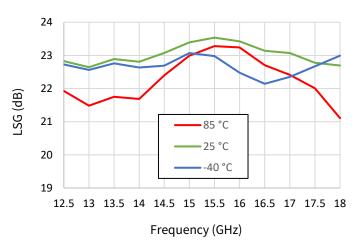


Figure 6: Ig v. Frequency v. Temperature

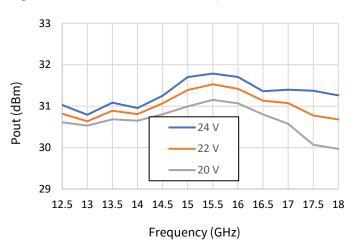




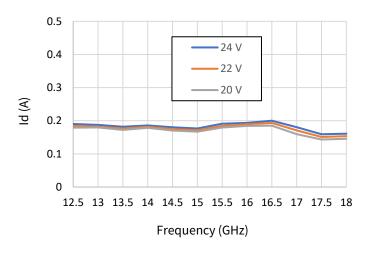


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#### Figure 8: Pout v. Frequency v. Vd









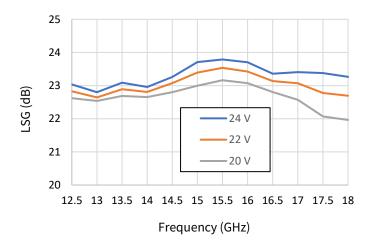


Figure 9: PAE v. Frequency v. Vd

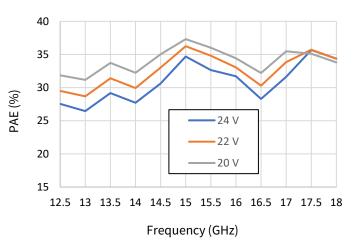
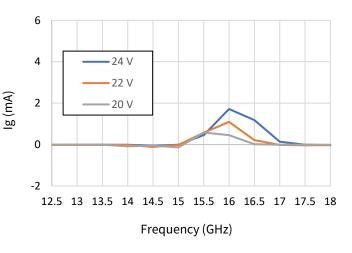


Figure 11: Ig v. Frequency v. Vd



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60 mA

30 mA

15 mA

Frequency (GHz)

#### Test conditions unless otherwise noted: Vd=22 V, Idq=30mA, CW, Pin = 8 dBm, T<sub>base</sub>=25 °C, Frequency: 15.5GHz

#### Figure 13: Pout v. Frequency v. Idq

33

32

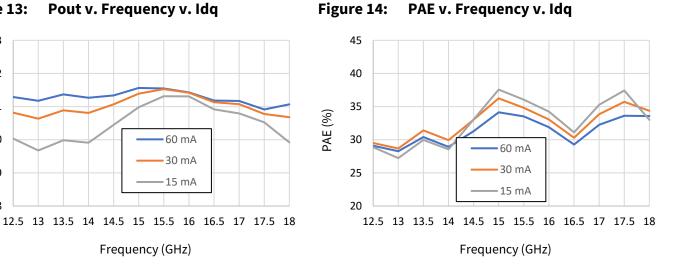
31

30

29

28

Pout (dBm)





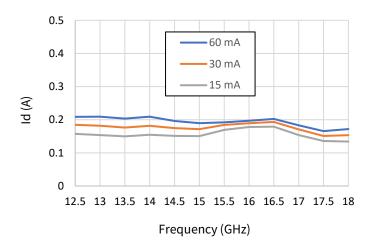
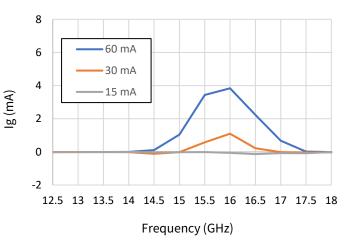
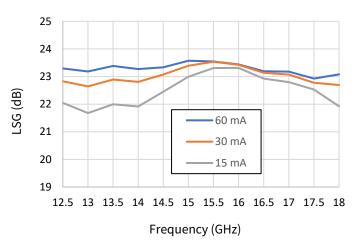


Figure 16: lg v. Frequency v. ldq







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12.7 GHz

15.5 GHz

18 GHz

6

8

10



34

32

30

28

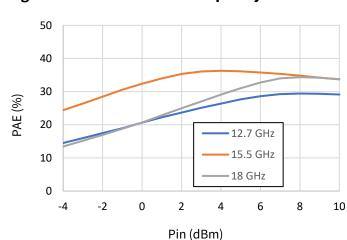
26

24

22

-4

Pout (dBm)







0

2

Pin (dBm)

4

-2

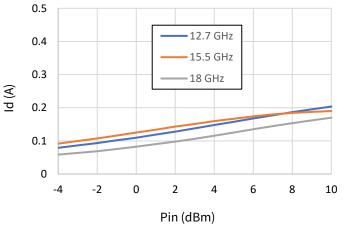
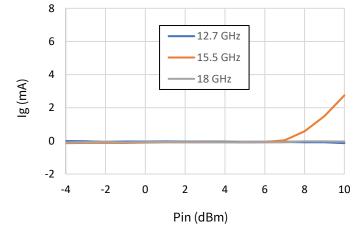
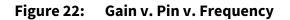
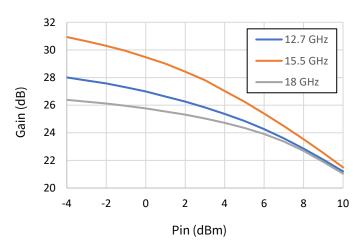


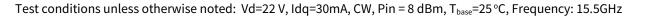
Figure 21: Ig v. Pin v. Frequency







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85 °C

25 °C

-40 °C

6

8

4

2

Pin (dBm)

#### Figure 23: Pout v. Pin v. Temperature

34

32

30

28

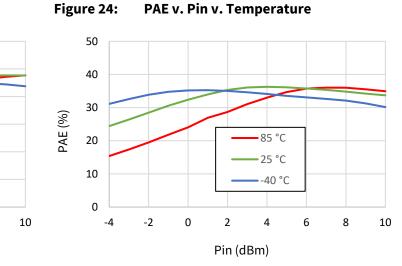
26

24

22

-4

Pout (dBm)





0



-2

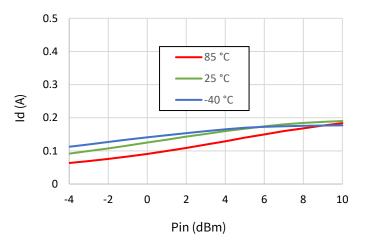
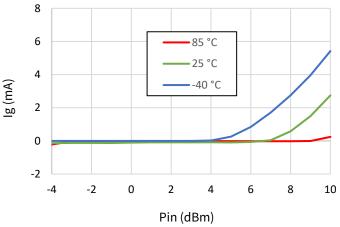
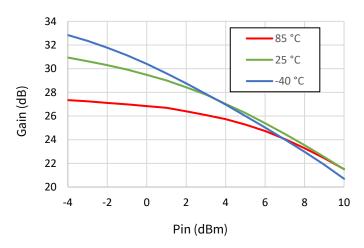


Figure 26: Ig v. Pin v. Temperature







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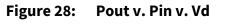
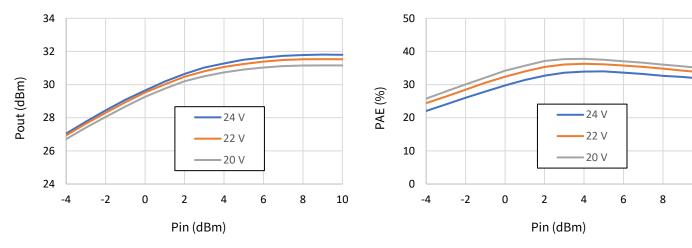


Figure 29: PAE v. Pin v. Vd





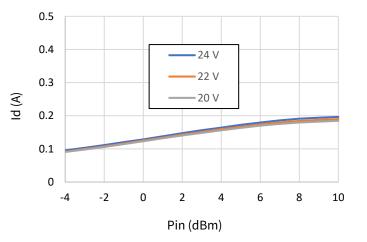
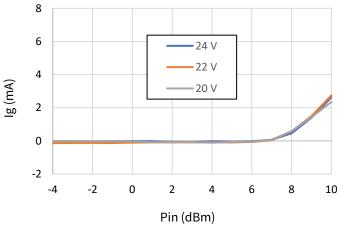
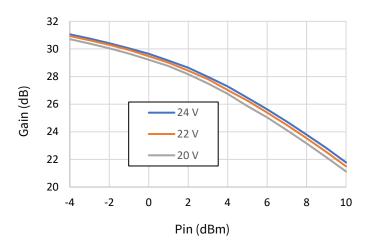


Figure 31: Ig v. Pin v. Vd







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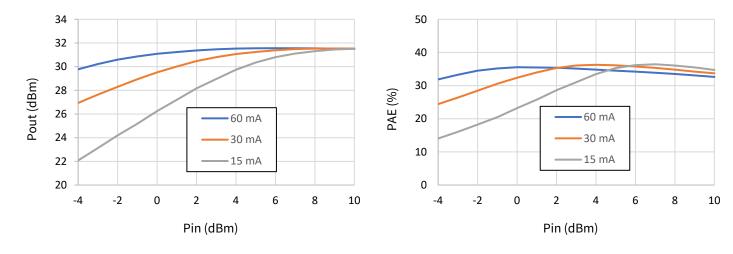
For further information and support please visit: <u>https://www.macom.com/support</u>

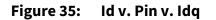
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Figure 34: PAE v. Pin v. Idq





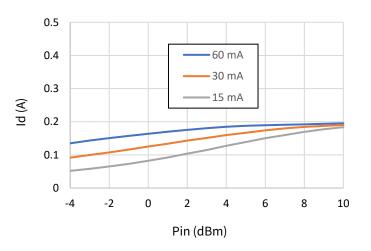
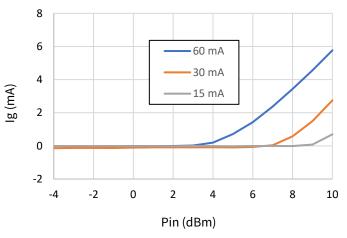
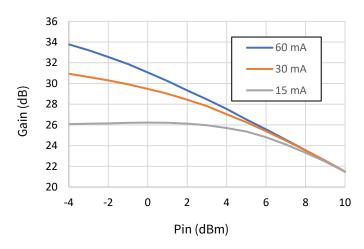


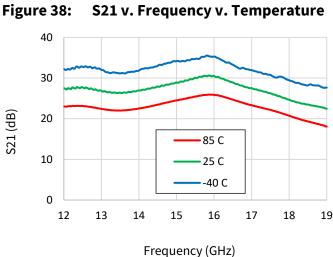
Figure 36: Ig v. Pin v. Idq







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Frequency (GHZ)



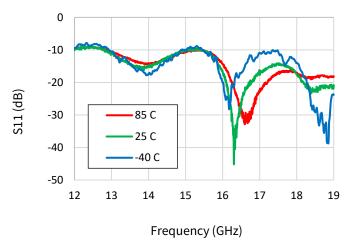
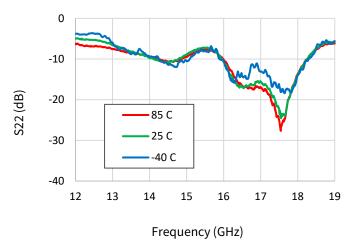
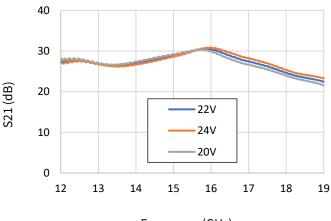


Figure 42: S22 v. Frequency v. Temperature







Frequency (GHz)

Figure 41: S11 v. Frequency v. Vd

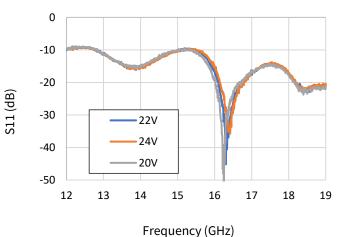
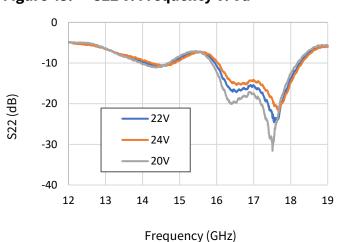
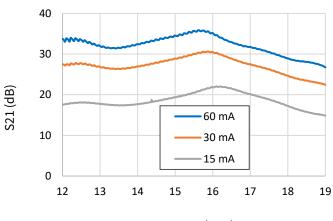


Figure 43: S22 v. Frequency v. Vd



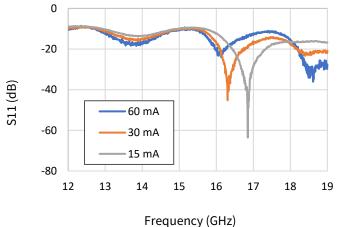
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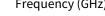
S21 v. Frequency v. Idq Figure 44:



Frequency (GHz)

Figure 45: S11 v. Frequency v. ldq





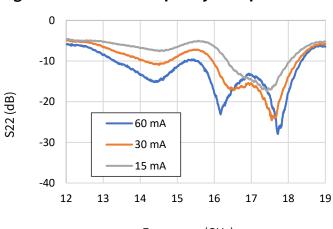
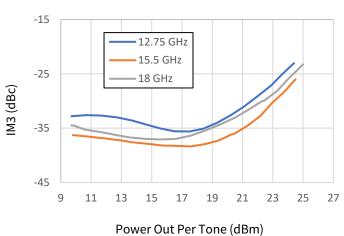


Figure 46: S22 v. Frequency v. Idq

Frequency (GHz)

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Test conditions unless otherwise noted: Vd=22 V, Idq=30mA, CW, Pin = 8 dBm,  $T_{base}$ =25 °C, Frequency: 15.5GHz, Tone Spacing = 10 MHz,  $T_{base}$ =25 °C



#### Figure 47: IM3 v. Pout/tone v. Frequency



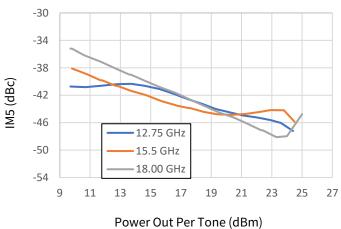
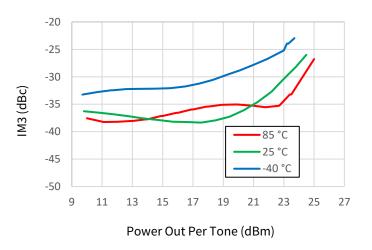
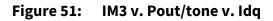


Figure 49: IM3 v. Pout/tone v. Temperature





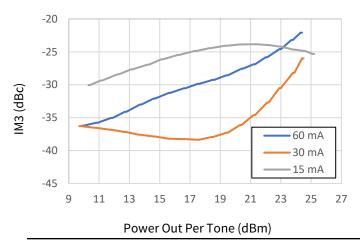


Figure 50: IM5 v. I

IM5 v. Pout/tone v. Temperature

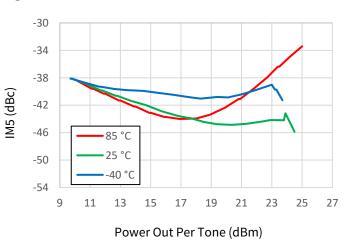
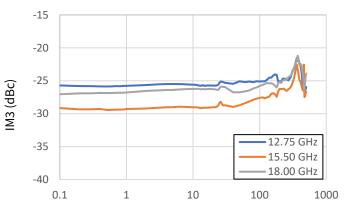


Figure 52: IM3 v. Tone Spacing v. Frequency



#### Tone Spacing (MHz)

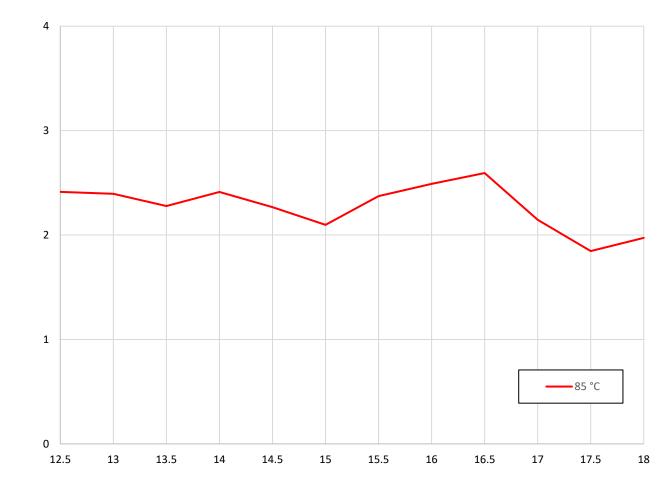
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#### **Thermal Characteristics**

Dissipated Watts (W)

Parameter	Symbol	Value	Operating Conditions
Operating Junction Temperature	ТJ	161.3	Freq = 15.5 GHz, $V_d$ = 22 V, $I_{dq}$ = 30 mA, $I_{drive}$ = 190 mA,
Thermal Resistance, Junction to Case	$R_{ heta JC}$	31.8	<ul> <li>Pin = 8 dBm, P<sub>out</sub> = 31 dBm, P<sub>diss</sub> = 2.4 W, T<sub>case</sub> = 85°C, CW</li> </ul>

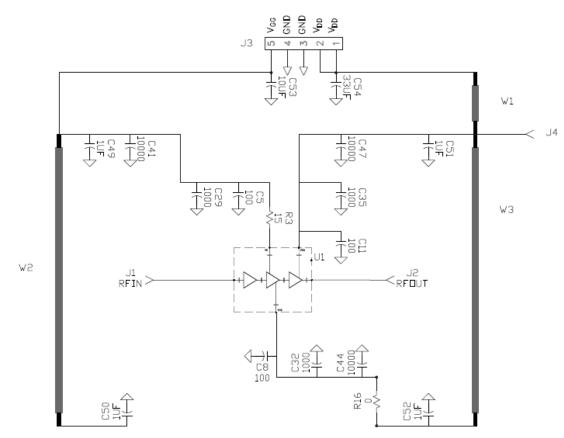
#### Power Dissipation v. Frequency (Tcase = 85°C)



Frequency (GHz)

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#### CMPA1D1J001S-AMP1 Evaluation Board Schematic Drawing

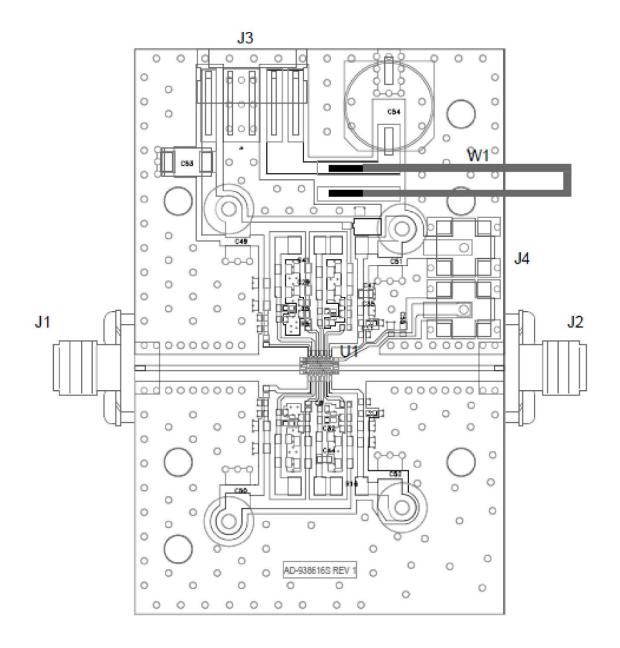


#### CMPA1D1J001S-AMP1 Evaluation Board Bill of Materials

Reference Designator	Description	Qty
C47, C41, C44	C0G, 10nF, +/-5%, 100V, 0603	3
C54	CAP, 33 UF, 20%, G CASE	1
C53	CAP, 10UF, 16V, TANTALUM	1
C11, C55, C5, C8	CAP, 100pF, +/-5%, 50V, 0402	4
R3	RES 15 OHM, +/-1%, 1/16W, 0402	1
C35, C29, C32	CAP, 1000PF, +/-5%, 100V, 0603	3
C49, C50, C51, C52	CAP, 1UF, 100V	4
R16	RES 0.0 OHM 1/16W 1206 SMD	1
-	PCB, RF-35, .010 THK, 3X4, 3-STAGE, QFN, CMPA1D1J001S	1
-	BASEPLATE 2.6"x1.7"x0.25" AL 3x4 QFN	
-	2-56 SOC HD SCREW 3/16 SS	
-	#2 SPLIT LOCKWASHER SS	4
J1, J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
J3	HEADER RT>PLZ .1CEN LK 5POS	1
W2, W3	WIRE, BLACK, 20 AWG	1
W1	WIRE, BLACK, 22 AWG	3
U1	CMPA1D1J001S	1

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#### CMPA1D1J001S-AMP1 Evaluation Board Assembly Drawing



Note: W2 and W3 are connected on backside

#### **Bias On Sequence**

- 1. Ensure RF is turned-off
- 2. Apply pinch-off voltage of -5 V to the gate (Vg)
- 3. Apply nominal drain voltage (Vd)
- 4. Adjust Vg to obtain desired quiescent drain current (Idq)
- 5. Apply RF

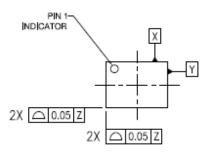
#### **Bias Off Sequence**

- 1. Turn RF off
- 2. Apply pinch-off to the gate (Vg=-5V)
- 3. Turn off drain voltage (Vd)
- 4. Turn off gate voltage (Vg)

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#### **Product Dimensions**

# SEATING PLANE

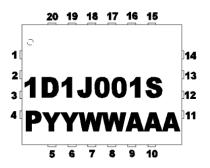


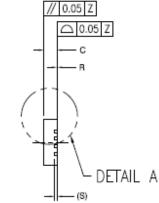
NOTES: UNLESS OTHERWISE SPECIFIED

 INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.

20

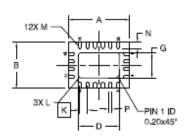
- NUMBER OF LAND PADS:
- THE CONTENTS OF THIS DRAWING ARE INTENDED TO REPRESENT THE PRODUCT IN MARKETING GRAPHICS ONLY AND NOT INTENDED TO BE USED FOR ANY PRODUCTION OR INTERNAL QUALIFICATION PURPOSE.





	INCHES			MILLIMETERS		
DIM	MIN	TYP	MAX	MIN	TYP	MAX
Α	,156	.157	.159	3,95	4.00	4.05
В	116	118	120	2,95	3,00	3,05
С	,033	.035	.037	0,85	0,90	0,95
D	.098	.104	.108	2.50	2.65	2.75
G	,059	.065	.069	1,50	1.65	1,75
к	-	.020	-	-	0,50	-
L	.004	.006	.008	0,10	0,15	0,20
M	.002	.003	.004	0.050	0,085	0,110
N	.012	.016	.020	0.30	0,40	0.50
Р	,005	.008	.010	0.13	0.20	0.25
R	.000	.001	.002	0.00	0.02	0.05
S	-	.008	-	-	0.20	-

TOP	V	E٧	V
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BOTTOM VIEW

#### SIDE VIEW

PIN	DESC	PIN	DESC
1	NC	11	RFGND
2	RFGND	12	RFOUT
3	RFIN	13	RFGND
4	RFGND	14	NC
5	NC	15	VD3
6	NC	16	NC
7	NC	17	NC
8	VD1,VD2	18	VG
9	NC	19	NC
10	NC	20	NC

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#### **Electrostatic Discharge (ESD) Classification**

Parameter	Symbol	Class	<b>Classification Level</b>	Test Methodology
Human body Model	HBM	TBD	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	TBD	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C

### **Product Ordering Information**

Part Number	Description	MOQ Increment	Image
CMPA1D1J001S	12.7 – 18 GHz, 1W GaN MMIC		CMPAIDIJOOIS
CMPA1D1J001S-AMP1	Evaluation Board w/ PA	1 Each	

Page 19

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